



**LM117L  
LM217L  
LM317L**

T-58-11-23

**Specifications and Applications Information**

**THREE-TERMINAL ADJUSTABLE OUTPUT POSITIVE VOLTAGE REGULATORS**

The LM117L/217L/317L are adjustable 3-terminal positive voltage regulators capable of supplying in excess of 100 mA over an output voltage range of 1.2 V to 37 V. These voltage regulators are exceptionally easy to use and require only two external resistors to set the output voltage. Further, they employ internal current limiting, thermal shutdown and safe area compensation, making them essentially blow-out proof.

The LM117L series serves a wide variety of applications including local, on card regulation. This device can also be used to make a programmable output regulator, or by connecting a fixed resistor between the adjustment and output, the LM117L series can be used as a precision current regulator.

- Output Current in Excess of 100 mA
- Output Adjustable Between 1.2 V and 37 V
- Internal Thermal Overload Protection
- Internal Short-Circuit Current Limiting
- Output Transistor Safe-Area Compensation
- Floating Operation for High Voltage Applications
- Standard 3-Lead Transistor Packages
- Eliminates Stocking Many Fixed Voltages

**LOW-CURRENT THREE-TERMINAL ADJUSTABLE POSITIVE VOLTAGE REGULATORS**

SILICON MONOLITHIC INTEGRATED CIRCUIT

Z SUFFIX  
PLASTIC PACKAGE  
CASE 29-04  
(LM317 only)

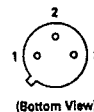
PIN 1. ADJUST  
2. V<sub>out</sub>  
3. V<sub>in</sub>



D SUFFIX  
PLASTIC PACKAGE  
CASE 751-03  
(SOP-8)



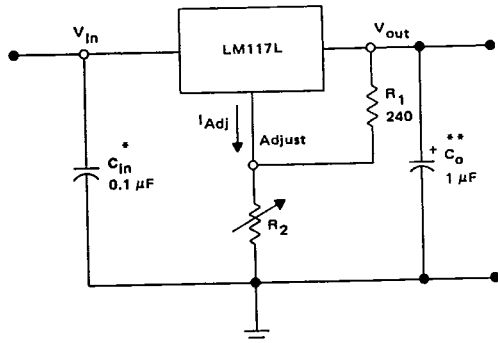
H SUFFIX  
METAL PACKAGE  
CASE 79-05



PIN 1. V<sub>in</sub>  
2. ADJUST  
3. V<sub>out</sub>

CASE IS OUTPUT

**STANDARD APPLICATION**



- \* = C<sub>in</sub> is required if regulator is located an appreciable distance from power supply filter.
- \*\* = C<sub>o</sub> is not needed for stability, however it does improve transient response.

$$V_{out} = 1.25 V \left( 1 + \frac{R_2}{R_1} \right) + I_{Adj} R_2$$

Since I<sub>Adj</sub> is controlled to less than 100 μA, the error associated with this term is negligible in most applications

**ORDERING INFORMATION**

Device	Tested Operating Temperature Range	Package
LM117LH	T <sub>J</sub> = -55°C to +150°C	Metal Can
LM217LH	T <sub>J</sub> = -25°C to +150°C	Metal Can
LM317LH	T <sub>J</sub> = 0°C to +125°C	Metal Can
LM317LZ		Plastic

## LM117L, LM217L, LM317L

T-58-11-23

## MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Input-Output Voltage Differential	$V_I - V_O$	40	Vdc
Power Dissipation	$P_D$	Internally Limited	
Operating Junction Temperature Range	$T_J$	-55 to +150 -25 to +150 0 to +150	°C
Storage Temperature Range	$T_{stg}$	-65 to +150	°C

## ELECTRICAL CHARACTERISTICS

 $(V_I - V_O = 5.0 \text{ V}; I_O = 40 \text{ mA}; T_J = T_{low} \text{ to } T_{high} \text{ [see Note 1]}; I_{max} \text{ and } P_{max} \text{ per Note 2; unless otherwise specified.})$ 

Characteristic	Figure	Symbol	LM117L/217L			LM317L			Unit
			Min	Typ	Max	Min	Typ	Max	
Line Regulation (Note 3) $T_A = 25^\circ\text{C}, 3.0 \text{ V} \leq V_I - V_O \leq 40 \text{ V}$	1	Regline	—	0.01	0.02	—	0.01	0.04	%V
Load Regulation (Note 3), $T_A = 25^\circ\text{C}$ $5.0 \text{ mA} \leq I_O \leq I_{max}$ — LM117L/217L $10 \text{ mA} \leq I_O \leq I_{max}$ — LM317L $V_O \leq 5.0 \text{ V}$ $V_O \geq 5.0 \text{ V}$	2	Regload	—	5.0 0.1	15 0.3	—	5.0 0.1	25 0.5	mV % $V_O$
Adjustment Pin Current	3	$I_{Adj}$	—	50	100	—	50	100	$\mu\text{A}$
Adjustment Pin Current Change $2.5 \text{ V} \leq V_I - V_O \leq 40 \text{ V}, P_D \leq P_{max}$ $5.0 \text{ mA} \leq I_O \leq I_{max}$ — LM117L/217L $10 \text{ mA} \leq I_O \leq I_{max}$ — LM317L	1,2	$\Delta I_{Adj}$	—	0.2	5.0	—	0.2	5.0	$\mu\text{A}$
Reference Voltage (Note 4) $3.0 \text{ V} \leq V_I - V_O \leq 40 \text{ V}, P_D \leq P_{max}$ $5.0 \text{ mA} \leq I_O \leq I_{max}$ — LM117L/217L $10 \text{ mA} \leq I_O \leq I_{max}$ — LM317L	3	$V_{ref}$	1.20	1.25	1.30	1.20	1.25	1.30	V
Line Regulation (Note 3) $3.0 \text{ V} \leq V_I - V_O \leq 40 \text{ V}$	1	Regline	—	0.02	0.05	—	0.02	0.07	%V
Load Regulation (Note 3) $5.0 \text{ mA} \leq I_O \leq I_{max}$ — LM117L/217L $10 \text{ mA} \leq I_O \leq I_{max}$ — LM317L $V_O \leq 5.0 \text{ V}$ $V_O \geq 5.0 \text{ V}$	2	Regload	—	20 0.3	50 1.0	—	20 0.3	70 1.5	mV % $V_O$
Temperature Stability ( $T_{low} \leq T_J \leq T_{high}$ )	3	$T_S$	—	0.7	—	—	0.7	—	% $V_O$
Minimum Load Current to Maintain Regulation ( $V_I - V_O = 40 \text{ V}$ )	3	$I_{Lmin}$	—	3.5	5.0	—	3.5	10	mA
Maximum Output Current $V_I - V_O \leq 20 \text{ V}, P_D \leq P_{max}$ , H Package $V_I - V_O \leq 6.25 \text{ V}, P_D \leq P_{max}$ , Z Package $V_I - V_O = 40 \text{ V}, P_D \leq P_{max}, T_A = 25^\circ\text{C}$ H Package Z Package	3	$I_{max}$	100 100	200 200	— —	100 100	200 200	— —	mA
RMS Noise, % of $V_O$ $T_A = 25^\circ\text{C}, 10 \text{ Hz} \leq f \leq 10 \text{ kHz}$	—	N	—	0.003	—	—	0.003	—	% $V_O$
Ripple Rejection (Note 5) $V_O = 1.25 \text{ V}, f = 120 \text{ Hz}$ $C_{ADJ} = 10 \mu\text{F}, V_O = 10.0 \text{ V}$	4	RR	66	80	—	60	80	—	dB
Long Term Stability, $T_J = T_{high}$ (Note 6) $T_A = 25^\circ\text{C}$ for Endpoint Measurements	3	S	—	0.3	1.0	—	0.3	1.0	%/1.0 k Hrs.
Thermal Resistance Junction to Case H Package Z Package	—	$R_{\theta JC}$	—	40	—	—	40	—	°C/W
Thermal Resistance Junction to Air H Package Z Package	—	$R_{\theta JA}$	—	185	—	—	185	—	°C/W

## NOTES:

- (1)  $T_{low} = -55^\circ\text{C}$  for LM117L  
-25°C for LM217L  
0°C for LM317L
- (2)  $I_{max} = 100 \text{ mA}$   
 $P_{max} = 2 \text{ W}$  for H Package  
= 625 mW for Z Package

$T_{high} = +150^\circ\text{C}$  for LM117L  
= +150°C for LM217L  
= +125°C for LM317L

- (3) Load and line regulation are specified at constant junction temperature. Changes in  $V_O$  due to heating effects must be taken into account separately. Pulse testing with low duty cycle is used.
- (4) Selected devices with tightened tolerance reference voltage available.
- (5)  $C_{ADJ}$ , when used, is connected between the adjustment pin and ground.
- (6) Since Long Term Stability cannot be measured on each device before shipment, this specification is an engineering estimate of average stability from lot to lot.

LM117L, LM217L, LM317L

T-58-11-23

SCHEMATIC DIAGRAM

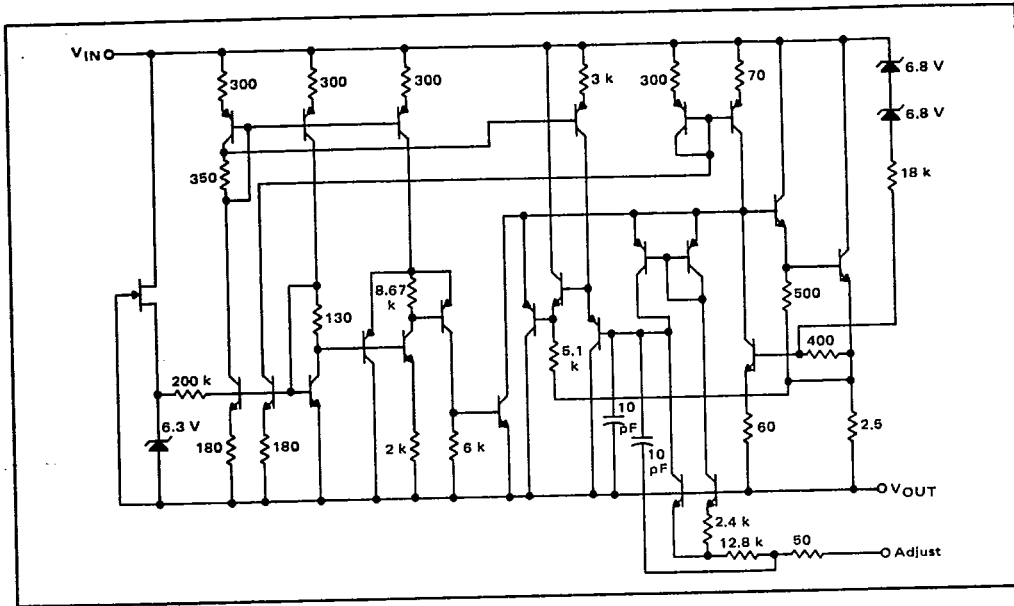
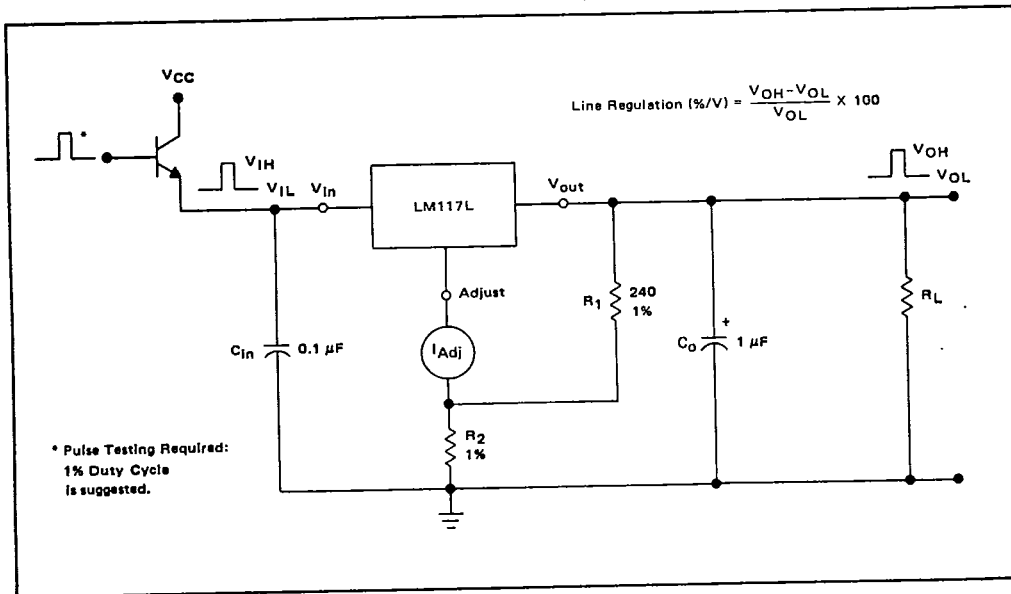


FIGURE 1 - LINE REGULATION AND  $\Delta I_{Adj}$ /LINE TEST CIRCUIT



LM117L, LM217L, LM317L

T-58-11-23

FIGURE 2 - LOAD REGULATION AND  $\Delta I_{Adj}$ /LOAD TEST CIRCUIT

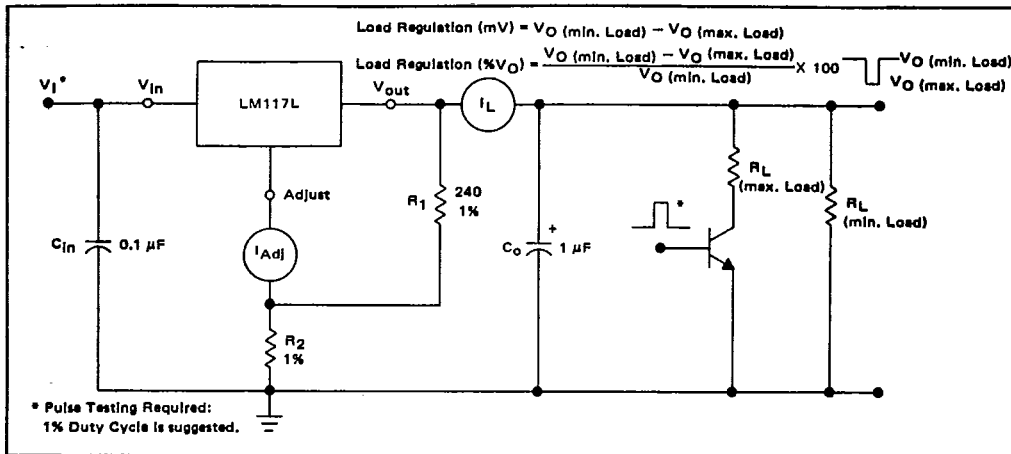


FIGURE 3 - STANDARD TEST CIRCUIT

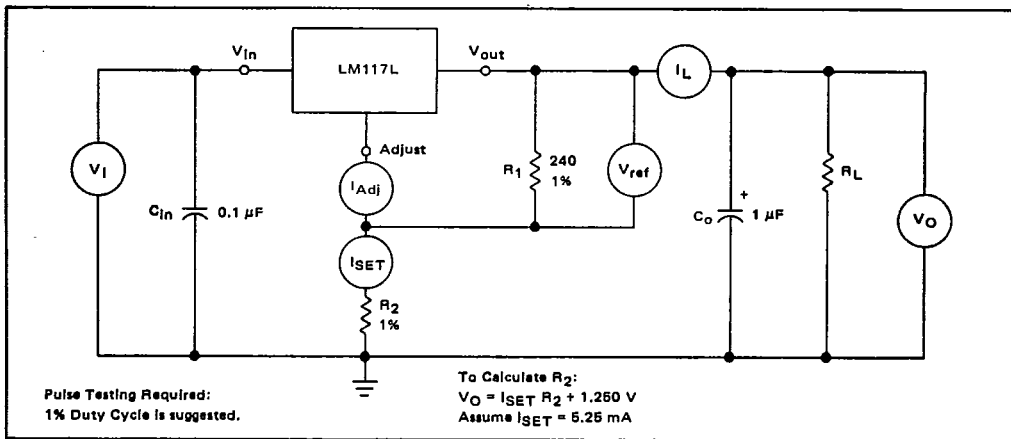


FIGURE 4 - RIPPLE REJECTION TEST CIRCUIT

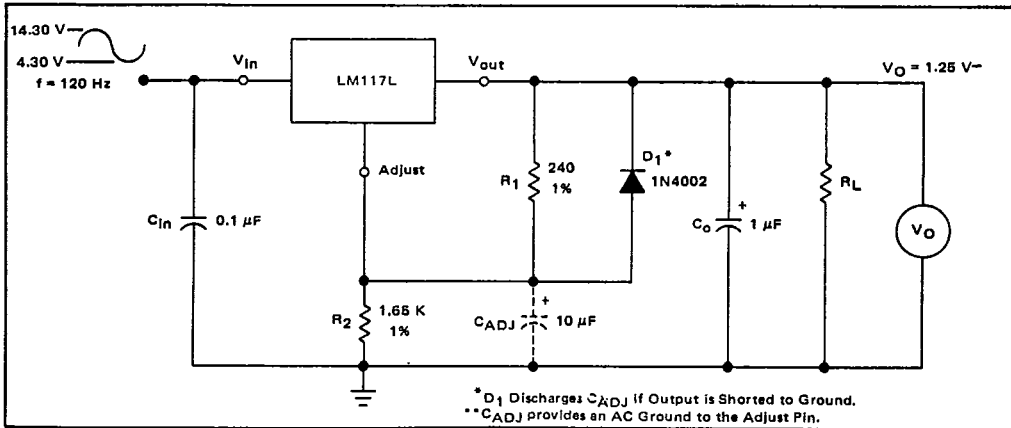


FIGURE 5 - LOAD REGULATION

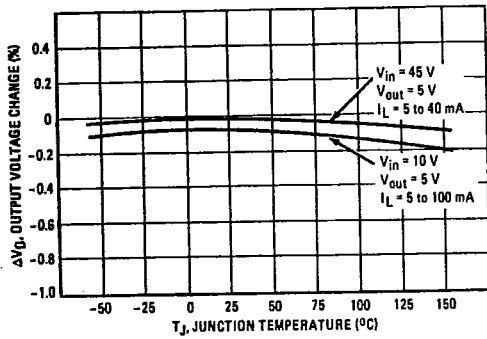


FIGURE 6 - RIPPLE REJECTION

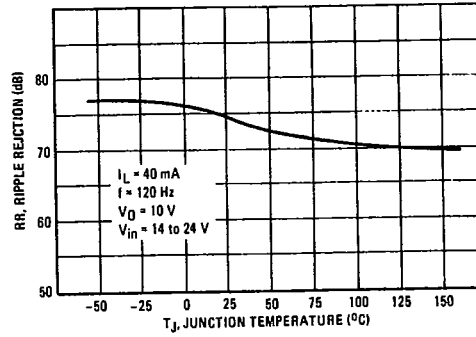


FIGURE 7 - CURRENT LIMIT

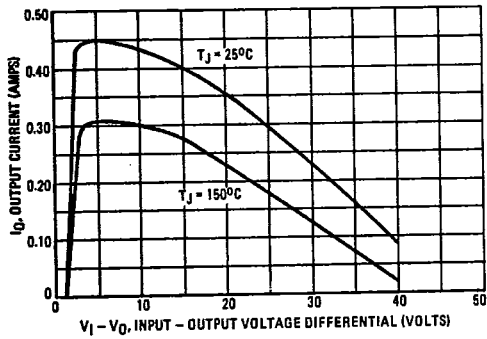


FIGURE 8 - DROPOUT VOLTAGE

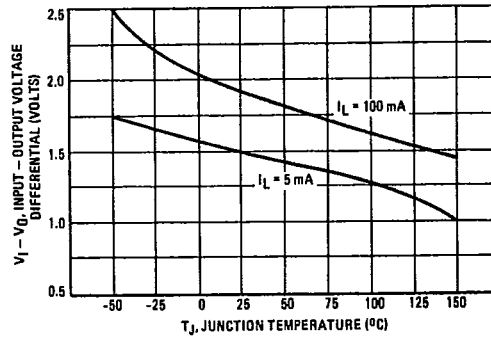


FIGURE 9 - MINIMUM OPERATING CURRENT

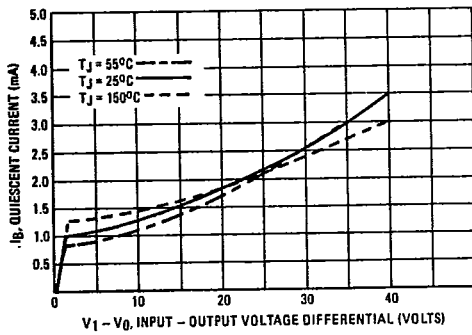
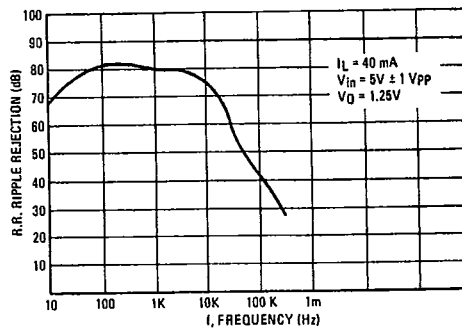


FIGURE 10 - RIPPLE REJECTION versus FREQUENCY



T-58-11-23

FIGURE 11 - TEMPERATURE STABILITY

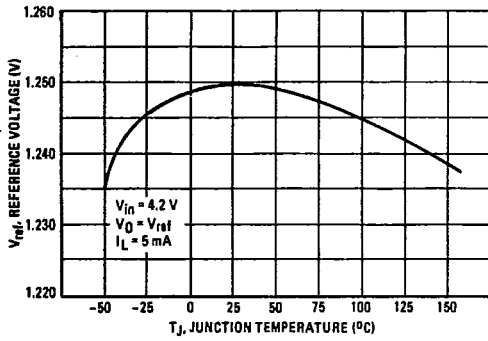


FIGURE 12 - ADJUSTMENT PIN CURRENT

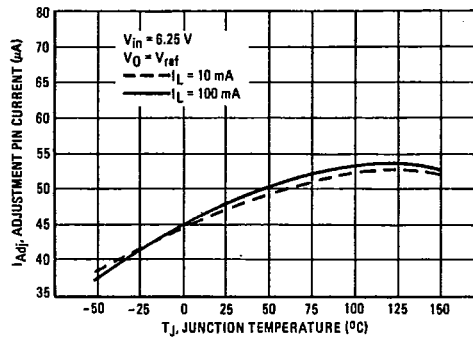


FIGURE 13 - LINE REGULATION

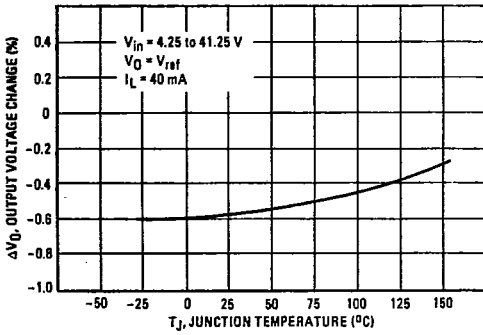


FIGURE 14 - OUTPUT NOISE

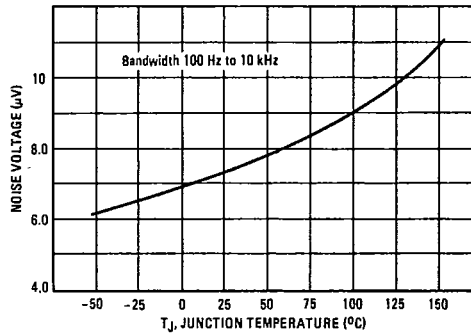


FIGURE 15 - LINE TRANSIENT RESPONSE

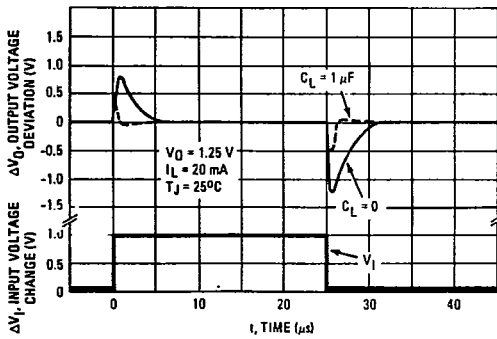
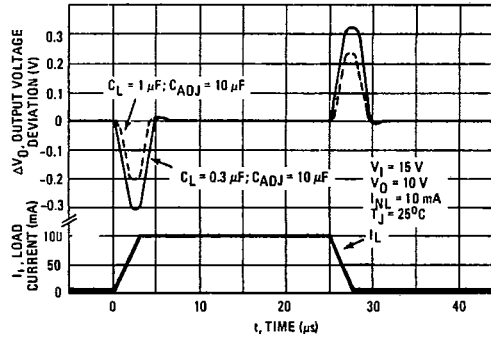


FIGURE 16 - LOAD TRANSIENT RESPONSE



## LM117L, LM217L, LM317L

T-58-11-23

## APPLICATIONS INFORMATION

## BASIC CIRCUIT OPERATION

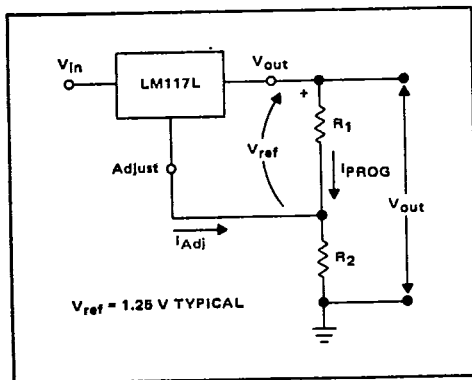
The LM117L is a 3-terminal floating regulator. In operation, the LM117L develops and maintains a nominal 1.25 volt reference ( $V_{ref}$ ) between its output and adjustment terminals. This reference voltage is converted to a programming current ( $I_{PROG}$ ) by  $R_1$  (see Figure 13), and this constant current flows through  $R_2$  to ground. The regulated output voltage is given by:

$$V_{out} = V_{ref} \left( 1 + \frac{R_2}{R_1} \right) + I_{Adj} R_2$$

Since the current from the adjustment terminal ( $I_{Adj}$ ) represents an error term in the equation, the LM117L was designed to control  $I_{Adj}$  to less than 100  $\mu A$  and keep it constant. To do this, all quiescent operating current is returned to the output terminal. This imposes the requirement for a minimum load current. If the load current is less than this minimum, the output voltage will rise.

Since the LM117L is a floating regulator, it is only the voltage differential across the circuit which is important to performance, and operation at high voltages with respect to ground is possible.

FIGURE 17 - BASIC CIRCUIT CONFIGURATION



## LOAD REGULATION

The LM117L is capable of providing extremely good load regulation, but a few precautions are needed to obtain maximum performance. For best performance, the programming resistor ( $R_1$ ) should be connected as close to the regulator as possible to minimize line drops which effectively appear in series with the reference, thereby degrading regulation. The ground end of  $R_2$  can be returned near the load ground to provide remote ground sensing and improve load regulation.

## EXTERNAL CAPACITORS

A 0.1  $\mu F$  disc or 1  $\mu F$  tantalum input bypass capacitor ( $C_{in}$ ) is recommended to reduce the sensitivity to input line impedance.

The adjustment terminal may be bypassed to ground to improve ripple rejection. This capacitor ( $C_{ADJ}$ ) prevents ripple from being amplified as the output voltage is increased. A 10  $\mu F$  capacitor should improve ripple rejection about 15dB at 120 Hz in a 10 volt application.

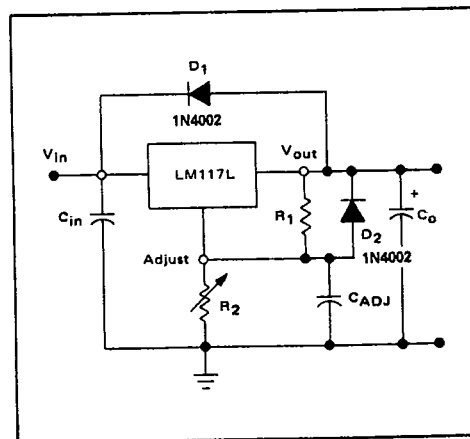
Although the LM117L is stable with no output capacitance, like any feedback circuit, certain values of external capacitance can cause excessive ringing. An output capacitance ( $C_o$ ) in the form of a 1  $\mu F$  tantalum or 25  $\mu F$  aluminum electrolytic capacitor on the output swamps this effect and insures stability.

## PROTECTION DIODES

When external capacitors are used with any I.C. regulator it is sometimes necessary to add protection diodes to prevent the capacitors from discharging through low current points into the regulator.

Figure 14 shows the LM117L with the recommended protection diodes for output voltages in excess of 25 V or high capacitance values ( $C_o > 10 \mu F$ ,  $C_{ADJ} > 5 \mu F$ ). Diode  $D_1$  prevents  $C_o$  from discharging thru the I.C. during an input short circuit. Diode  $D_2$  protects against capacitor  $C_{ADJ}$  discharging through the I.C. during an output short circuit. The combination of diodes  $D_1$  and  $D_2$  prevents  $C_{ADJ}$  from discharging through the I.C. during an input short circuit.

FIGURE 18 - VOLTAGE REGULATOR WITH PROTECTION DIODES



T-58-11-23

FIGURE 19 - ADJUSTABLE CURRENT LIMITER

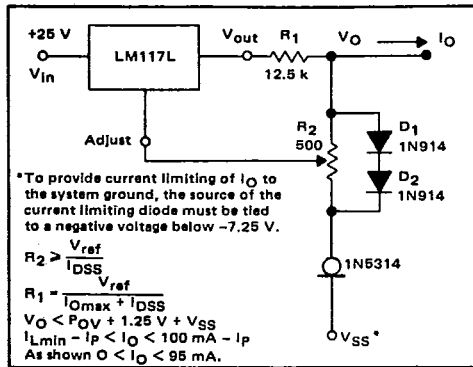


FIGURE 20 - 5 V ELECTRONIC SHUTDOWN REGULATOR

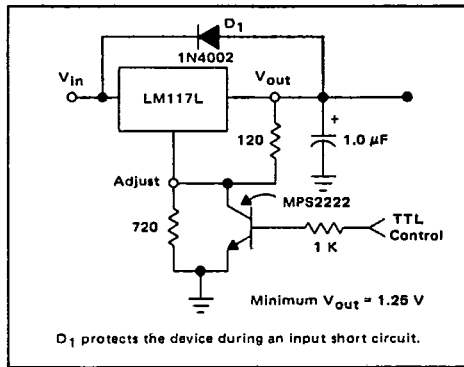


FIGURE 21 - SLOW TURN-ON REGULATOR

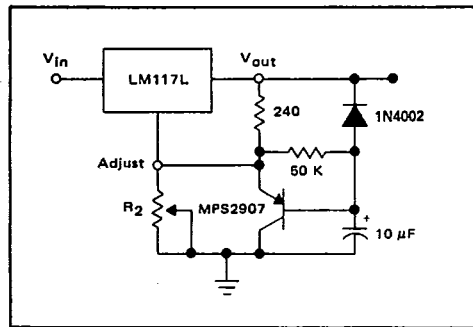
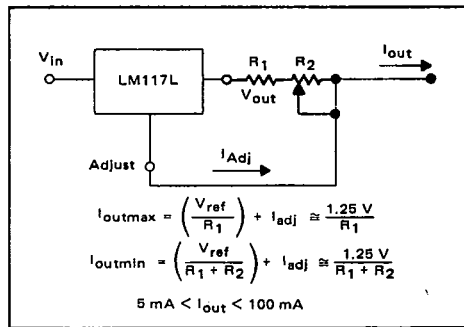


FIGURE 22 - CURRENT REGULATOR





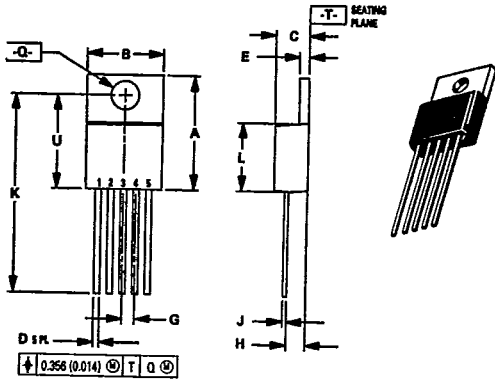


PACKAGE OUTLINE DIMENSIONS (continued)

**T SUFFIX  
PLASTIC PACKAGE  
CASE 314D-02**

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	14.529	15.570	0.572	0.613
B	9.908	10.541	0.390	0.415
C	4.318	4.572	0.170	0.180
D	0.635	0.965	0.025	0.038
E	1.169	1.397	0.046	0.055
G	1.702 BSC		0.067 BSC	
H	2.109	2.717	0.083	0.107
J	0.381	0.635	0.015	0.025
K	25.907	26.670	1.016	1.050
L	8.052	9.398	0.317	0.370
Q	3.556	3.937	0.140	0.155
U	11.893	12.827	0.468	0.505

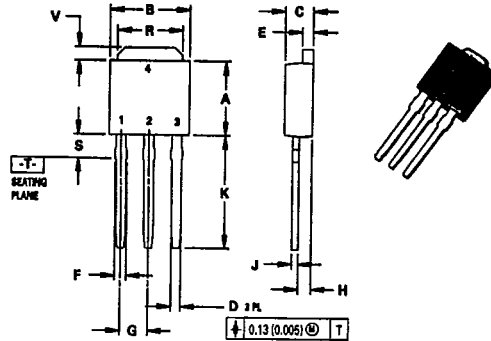
NOTES:  
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.  
2. CONTROLLING DIMENSION: INCH.



**DT-1 SUFFIX  
PLASTIC PACKAGE  
CASE 369-03**

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	5.97	6.22	0.235	0.245
B	6.35	6.73	0.250	0.265
C	2.19	2.38	0.086	0.094
D	0.69	0.88	0.027	0.035
E	0.84	0.94	0.033	0.037
F	0.77	1.14	0.030	0.045
G	2.29 BSC		0.090 BSC	
H	0.97	1.06	0.038	0.042
J	0.46	0.58	0.018	0.023
K	8.89	9.65	0.350	0.380
R	5.21	5.46	0.205	0.215
S	1.91	2.28	0.075	0.090
V	0.89	1.27	0.035	0.050

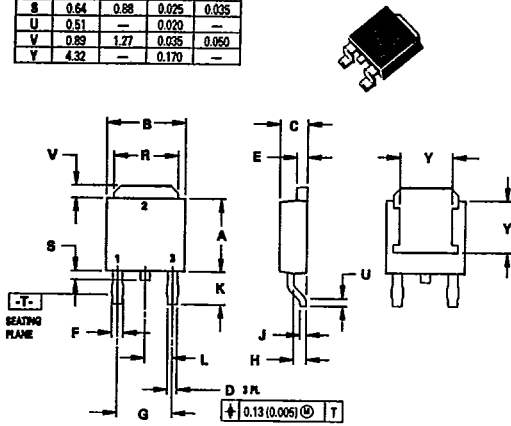
NOTES:  
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.  
2. CONTROLLING DIMENSION: INCH.



**DT SUFFIX  
PLASTIC PACKAGE  
CASE 369A-03  
DPAK**

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	5.97	6.22	0.235	0.245
B	6.35	6.73	0.250	0.265
C	2.19	2.38	0.086	0.094
D	0.69	0.88	0.027	0.035
E	0.84	0.94	0.033	0.037
F	0.77	1.14	0.030	0.045
G	4.58 BSC		0.180 BSC	
H	0.97	1.06	0.038	0.042
J	0.46	0.58	0.018	0.023
K	2.60	2.89	0.102	0.114
L	2.29 BSC		0.090 BSC	
R	5.21	5.46	0.205	0.215
S	0.64	0.88	0.025	0.035
U	0.51	—	0.020	—
V	0.89	1.27	0.035	0.050
Y	4.32	—	0.170	—

NOTES:  
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.  
2. CONTROLLING DIMENSION: INCH.

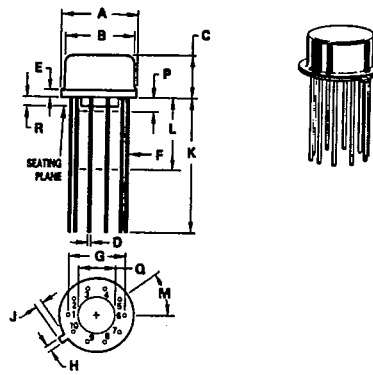


**H, G SUFFIX  
METAL PACKAGE  
CASE 603-04  
R<sub>θJA</sub> = 160°C/W  
(TO-100)**

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	8.51	9.29	0.335	0.370
B	7.25	8.51	0.285	0.335
C	4.19	4.70	0.165	0.185
D	0.407	0.533	0.016	0.021
E	—	1.02	—	0.040
F	0.406	0.483	0.016	0.019
G	5.84 BSC		0.230 BSC	
H	0.712	0.864	0.028	0.034
J	0.737	1.14	0.029	0.045
K	12.70	—	0.500	—
L	6.35	12.70	0.250	0.500
M	36° BSC		36° BSC	
P	—	1.27	—	0.050
Q	3.56	4.06	0.140	0.160
R	0.254	1.02	0.010	0.040

NOTE:  
LEADS WITHIN 0.18 mm (0.007) RADIUS OF TRUE POSITION AT SEATING PLANE AT MAXIMUM MATERIAL CONDITION.

All JEDEC Dimensions and Notes Apply.

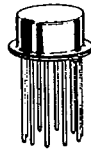
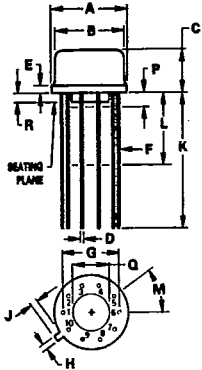


PACKAGE OUTLINE DIMENSIONS (continued)

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	8.51	9.39	0.335	0.370
B	7.75	8.51	0.305	0.335
C	4.19	6.73	0.165	0.265
D	0.407	0.533	0.016	0.021
E	—	1.02	—	0.040
F	0.406	0.483	0.016	0.019
G	5.84 BSC		0.230 BSC	
H	0.712	0.864	0.028	0.034
J	0.737	1.14	0.029	0.045
K	12.70	—	0.500	—
L	6.35	12.70	0.250	0.500
M	36° BSC		36° BSC	
P	—	1.27	—	0.050
Q	3.56	4.06	0.140	0.160
R	0.254	1.02	0.010	0.040

**G SUFFIX  
METAL PACKAGE  
CASE 603C-01**  
R $\theta$ JA = 150°C/W (TYP)  
(TO-100)

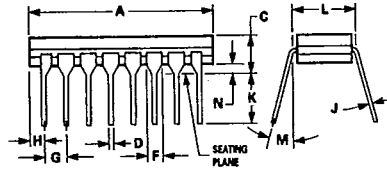
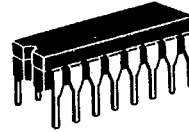
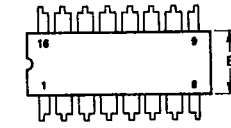
- NOTES:  
1. LEADS WITHIN 0.18 mm (0.007) RADIUS OF TRUE POSITION TO DIM. "A" & "H" AT SEATING PLANE AT MAXIMUM MATERIAL CONDITION.  
2. LEAD DIA UNCONTROLLED BEYOND DIM "K" MIN.



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	19.05	19.94	0.750	0.785
B	6.10	7.49	0.240	0.295
C	—	5.08	—	0.200
D	0.38	0.53	0.015	0.021
F	1.40	1.78	0.055	0.070
G	2.54 BSC		0.100 BSC	
H	0.51	1.14	0.020	0.045
J	0.20	0.30	0.008	0.012
K	3.18	4.32	0.125	0.170
L	7.62 BSC		0.300 BSC	
M	—	15°	—	15°
N	0.51	1.02	0.020	0.040

**DP2, D, J, L, N SUFFIX  
CERAMIC PACKAGE  
CASE 620-10**  
R $\theta$ JA = 100°C/W (TYP)

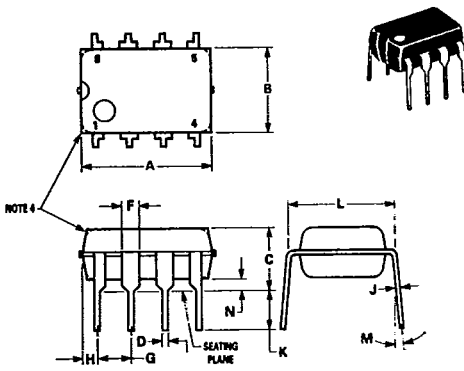
- NOTES:  
1. LEADS WITHIN 0.13 mm (0.005) RADIUS OF TRUE POSITION AT SEATING PLANE AT MAXIMUM MATERIAL CONDITION.  
2. PACKAGE INDEX: NOTCH IN LEAD NOTCH IN CERAMIC OR INK DOT.  
3. DIM "L" TO CENTER OF LEADS WHEN FORMED PARALLEL.  
4. DIM "A" AND "B" DO NOT INCLUDE GLASS RUN-OUT.  
5. DIM "F" MAY NARROW TO 0.76 mm (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.



**N, P1 SUFFIX  
PLASTIC PACKAGE  
CASE 626-05**  
R $\theta$ JA = 100°C/W (TYP)

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	9.40	10.16	0.370	0.400
B	6.10	6.60	0.240	0.260
C	3.94	4.45	0.155	0.175
D	0.38	0.51	0.015	0.020
F	1.02	1.52	0.040	0.060
G	2.54 BSC		0.100 BSC	
H	0.76	1.27	0.030	0.050
J	0.20	0.30	0.008	0.012
K	2.92	3.43	0.115	0.135
L	7.62 BSC		0.300 BSC	
M	—	10°	—	10°
N	0.76	1.01	0.030	0.040

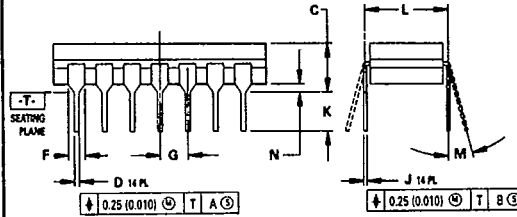
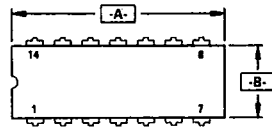
- NOTES:  
1. LEAD POSITIONAL TOLERANCE:  
 $\pm 0.13 (0.005) \text{ T A } \text{B}$   
2. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.  
3. PACKAGE CONTOUR OPTIONAL (ROUND OR SQUARE CORNERS).  
4. DIMENSIONS A AND B ARE DATUMS.  
5. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.



**L SUFFIX  
CERAMIC PACKAGE  
CASE 632-08**  
R $\theta$ JA = 100°C/W (TYP)  
(TO-116)

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	19.05	19.94	0.750	0.785
B	6.23	7.11	0.245	0.280
C	3.94	5.08	0.155	0.200
D	0.39	0.50	0.015	0.020
F	1.40	1.65	0.055	0.065
G	2.54 BSC		0.100 BSC	
J	0.21	0.38	0.008	0.015
K	3.18	4.31	0.125	0.170
L	7.62 BSC		0.300 BSC	
M	0°	15°	0°	15°
N	0.51	1.01	0.020	0.040

- NOTES:  
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.  
2. CONTROLLING DIMENSION: INCH.  
3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.  
4. DIM F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.

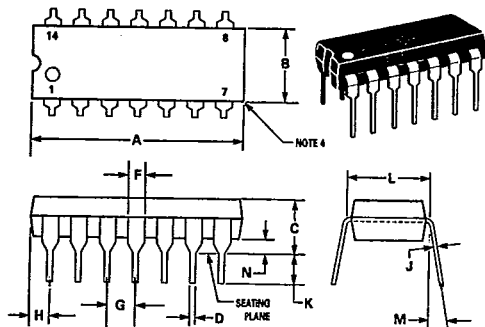


PACKAGE OUTLINE DIMENSIONS (continued)

**N, P, N-14, P2 SUFFIX  
PLASTIC PACKAGE  
CASE 646-06**  
 $R_{\theta JA} = 100^{\circ}\text{C/W (TYP)}$

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	18.16	19.56	0.715	0.770
B	6.10	6.60	0.240	0.260
C	3.69	4.69	0.145	0.185
D	0.39	0.53	0.015	0.021
F	1.02	1.79	0.040	0.070
G	2.54 BSC		0.100 BSC	
H	1.22	2.41	0.052	0.095
J	0.20	0.38	0.008	0.015
K	2.92	3.43	0.115	0.135
L	7.62 BSC		0.300 BSC	
M	0°	10°	0°	10°
N	0.39	1.01	0.015	0.039

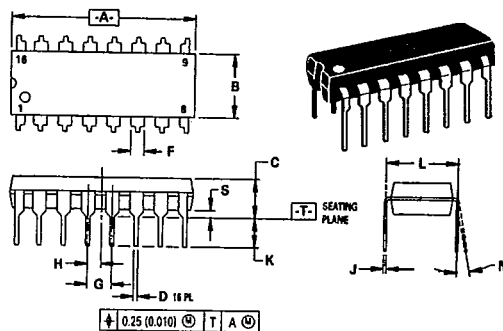
- NOTES:
- LEADS WITHIN 0.13 mm (0.005) RADIUS OF TRUE POSITION AT SEATING PLANE AT MAXIMUM MATERIAL CONDITION.
  - DIMENSION "L" TO CENTER OF LEADS WHEN FORMED PARALLEL.
  - DIMENSION "B" DOES NOT INCLUDE MOLD FLASH.
  - ROUNDED CORNERS OPTIONAL.



**N, P SUFFIX  
PLASTIC PACKAGE  
CASE 648-08**  
 $R_{\theta JA} = 100^{\circ}\text{C/W (TYP)}$

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	18.80	19.55	0.740	0.770
B	6.35	6.85	0.250	0.270
C	3.69	4.44	0.145	0.175
D	0.39	0.53	0.015	0.021
F	1.02	1.77	0.040	0.070
G	2.54 BSC		0.100 BSC	
H	1.27 BSC		0.050 BSC	
J	0.21	0.38	0.008	0.015
K	2.80	3.30	0.110	0.130
L	7.50	7.74	0.295	0.305
M	0°	10°	0°	10°
S	0.51	1.01	0.020	0.040

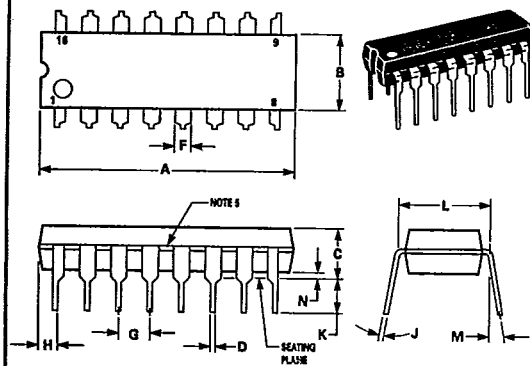
- NOTES:
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  - CONTROLLING DIMENSION: INCH.
  - DIMENSION "L" TO CENTER OF LEADS WHEN FORMED PARALLEL.
  - DIMENSION "B" DOES NOT INCLUDE MOLD FLASH.
  - ROUNDED CORNERS OPTIONAL.



**P SUFFIX  
PLASTIC PACKAGE  
CASE 648C-02**

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	18.80	21.34	0.740	0.840
B	6.10	6.50	0.240	0.260
C	3.69	4.69	0.145	0.185
D	0.39	0.53	0.015	0.021
F	1.02	1.78	0.040	0.070
G	2.54 BSC		0.100 BSC	
H	0.39	2.41	0.015	0.095
J	0.20	0.38	0.008	0.015
K	2.92	3.43	0.115	0.135
L	7.62 BSC		0.300 BSC	
M	0°	10°	0°	10°
N	0.39	1.01	0.015	0.040

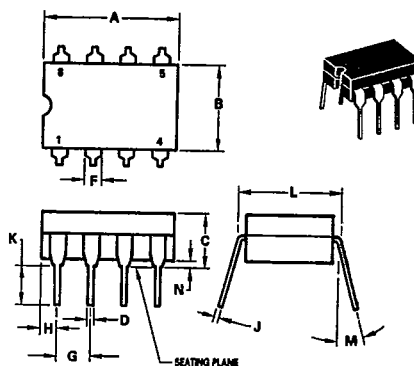
- NOTES:
- LEADS WITHIN 0.13 mm (0.005) RADIUS OF TRUE POSITION AT SEATING PLANE AT MAXIMUM MATERIAL CONDITION.
  - DIMENSION "L" TO CENTER OF LEADS WHEN FORMED PARALLEL.
  - DIMENSION "B" DOES NOT INCLUDE MOLD FLASH.
  - ROUNDED CORNERS OPTIONAL.
  - EXTERNAL LEAD CONNECTION, BETWEEN 4 AND 5, 12 AND 13 AS SHOWN.



**J-8, J, JG, U, Z SUFFIX  
CERAMIC PACKAGE  
CASE 693-02**  
 $R_{\theta JA} = 100^{\circ}\text{C/W (TYP)}$

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	9.91	10.92	0.390	0.430
B	6.22	6.99	0.245	0.275
C	4.32	5.08	0.170	0.200
D	0.41	0.51	0.016	0.020
F	1.40	1.65	0.055	0.065
G	2.54 BSC		0.100 BSC	
H	1.14	1.65	0.045	0.065
J	0.20	0.30	0.008	0.012
K	3.18	4.06	0.125	0.160
L	7.37	7.87	0.290	0.310
M	—	15°	—	15°
N	0.51	1.02	0.020	0.040

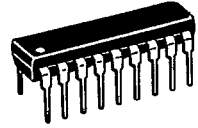
- NOTES:
- LEADS WITHIN 0.13 mm (0.005) RAD OF TRUE POSITION AT SEATING PLANE AT MAXIMUM MATERIAL CONDITION.
  - DIMENSION "L" TO CENTER OF LEADS WHEN FORMED PARALLEL.



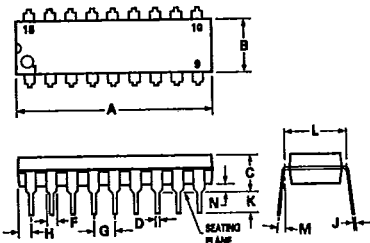
PACKAGE OUTLINE DIMENSIONS (continued)

**A, B, N, P SUFFIX  
PLASTIC PACKAGE  
CASE 707-02**  
R<sub>θJA</sub> = 100°C/W (TYP)

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	22.22	23.24	0.875	0.915
B	6.10	6.60	0.240	0.260
C	3.58	4.57	0.140	0.180
D	0.26	0.56	0.014	0.022
F	1.27	1.78	0.050	0.070
G	2.54 BSC		0.100 BSC	
H	1.02	1.52	0.040	0.060
J	0.20	0.30	0.008	0.012
K	2.92	3.43	0.115	0.135
L	7.62 BSC		0.300 BSC	
M	0°	15°	0°	15°
N	0.51	1.02	0.020	0.040



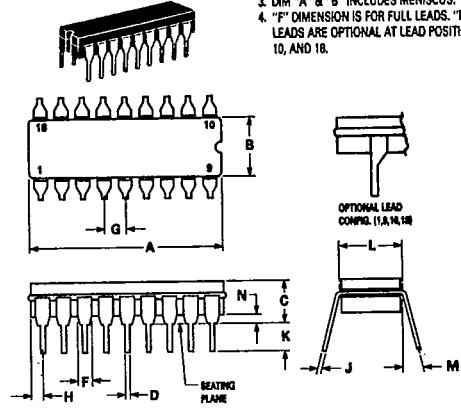
- NOTES:
1. POSITIONAL TOLERANCE OF LEADS (D), SHALL BE WITHIN 0.25mm(0.010) AT MAXIMUM MATERIAL CONDITION, IN RELATION TO SEATING PLANE AND EACH OTHER.
  2. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
  3. DIMENSION B DOES NOT INCLUDE MOLD FLASH.



**J, L SUFFIX  
CERAMIC PACKAGE  
CASE 726-04**  
R<sub>θJA</sub> = 100°C/W (TYP)

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	22.35	23.11	0.880	0.910
B	6.10	7.49	0.240	0.295
C	5.08		0.200	
D	0.38	0.53	0.015	0.021
F	1.40	1.78	0.055	0.070
G	2.54 BSC		0.100 BSC	
H	0.51	1.14	0.020	0.045
J	0.20	0.30	0.008	0.012
K	3.18	4.32	0.125	0.170
L	7.62 BSC		0.300 BSC	
M	0°	15°	0°	15°
N	0.51	1.02	0.020	0.040

- NOTES:
1. LEADS, TRUE POSITIONED WITHIN 0.25 mm (0.010) DIA. AT SEATING PLANE, AT MAXIMUM MATERIAL CONDITION.
  2. DIM "L" TO CENTER OF LEADS WHEN FORMED PARALLEL.
  3. DIM "A" & "B" INCLUDES MENISCUS.
  4. "F" DIMENSION IS FOR FULL LEADS. "HALF" LEADS ARE OPTIONAL AT LEAD POSITIONS 1, 9, 10, AND 18.

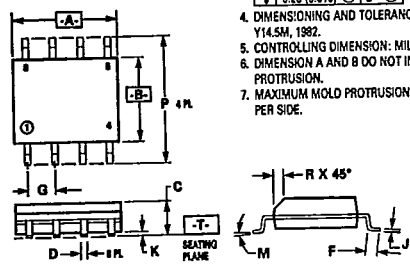


**D SUFFIX  
CASE 751-03  
PLASTIC PACKAGE  
SO-8, SOP-8**  
R<sub>θJA</sub> = 190°C/W (SO-8)  
R<sub>θJA</sub> = 160°C/W (SOP-8)

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.80	5.00	0.189	0.198
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019



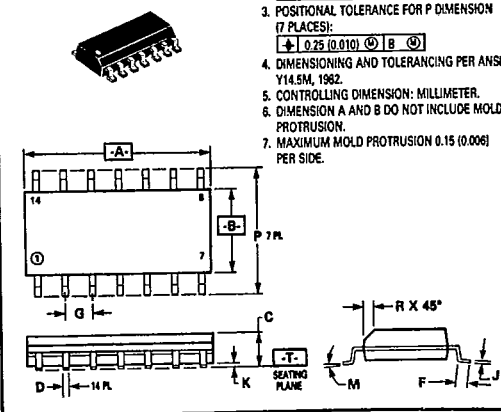
- NOTES:
1. DIMENSIONS A AND B ARE DATUMS AND T IS A DATUM SURFACE.
  2. POSITIONAL TOLERANCE FOR D DIMENSION (8 PLACES):  
±0.25 (0.010) (M) T B (L) A (M)
  3. POSITIONAL TOLERANCE FOR P DIMENSION (4 PLACES):  
±0.25 (0.010) (M) B (M)
  4. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  5. CONTROLLING DIMENSION: MILLIMETER.
  6. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
  7. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.



**D SUFFIX  
PLASTIC PACKAGE  
CASE 751A-02  
SO-14**  
R<sub>θJA</sub> = 145°C/W (TYP)

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	8.55	8.75	0.337	0.344
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019

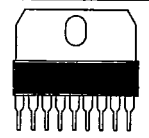
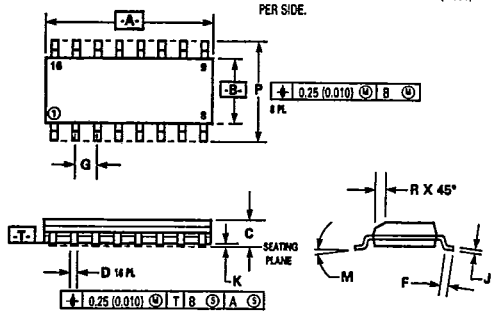
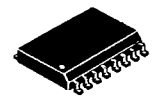
- NOTES:
1. DIMENSIONS A AND B ARE DATUMS AND T IS A DATUM SURFACE.
  2. POSITIONAL TOLERANCE FOR D DIMENSION (14 PLACES):  
±0.25 (0.010) (M) T B (L) A (M)
  3. POSITIONAL TOLERANCE FOR P DIMENSION (7 PLACES):  
±0.25 (0.010) (M) B (M)
  4. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  5. CONTROLLING DIMENSION: MILLIMETER.
  6. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
  7. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.



**DW SUFFIX  
PLASTIC PACKAGE  
CASE 751G-01  
SO-16L**

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	10.15	10.45	0.400	0.411
B	7.40	7.60	0.292	0.299
C	2.35	2.65	0.093	0.104
D	0.35	0.49	0.014	0.019
F	0.50	0.90	0.020	0.035
G	1.27 BSC		0.050 BSC	
J	0.25	0.32	0.010	0.012
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	10.05	10.65	0.395	0.415
	0.25	0.75	0.010	0.029

- NOTES:
1. DIMENSIONS A AND B ARE DATUMS AND T IS A DATUM SURFACE.
  2. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  3. CONTROLLING DIMENSION: MILLIMETER.
  4. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
  5. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.



**CASE 762-01  
PLASTIC MEDIUM  
POWER PACKAGE  
SIP-9**

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	22.40	23.00	0.873	0.907
B	6.40	6.80	0.252	0.269
C	3.45	3.65	0.135	0.143
D	0.40	0.55	0.015	0.021
E	0.35	0.60	0.009	0.024
F	1.40	1.60	0.055	0.062
G	2.54 BSC		0.100 BSC	
H	1.81	1.71	0.069	0.067
J	0.380	0.400	0.014	0.015
K	3.95	4.20	0.155	0.165
M	30° BSC		30° BSC	
N	2.50	2.70	0.099	0.106
Q	3.15	3.45	0.124	0.135
R	13.80	13.90	0.539	0.547
S	1.65	1.95	0.064	0.076
U	22.00	22.20	0.866	0.874
V	0.55	0.75	0.021	0.029
W	2.89 BSC		0.113 BSC	
X	0.85	0.75	0.033	0.029
Y	2.70	2.90	0.106	0.110

- NOTES:
1. DIMENSIONS A, AND C ARE DATUMS. AND -T- IS A DATUM PLANE.
  2. POSITIONAL TOLERANCE FOR LEAD DIMENSION D:  $\pm 0.25 (0.010) \text{ (M)} | -T- | A \text{ (M)}$
  3. POSITIONAL TOLERANCE FOR LEAD DIMENSION J:  $\pm 0.25 (0.010) \text{ (M)} | -T- | C \text{ (M)}$
  4. POSITIONAL TOLERANCE FOR LEAD DIMENSION Q:  $\pm 0.25 (0.010) \text{ (M)} | -T- | A \text{ (M)}$
  5. DIMENSIONING AND TOLERANCING PER ANSI Y14.5, 1982.
  6. CONTROLLING DIMENSION: MILLIMETER.

